Switching Diode

DA3X102D0L

Panasonic

DA3X102D0L

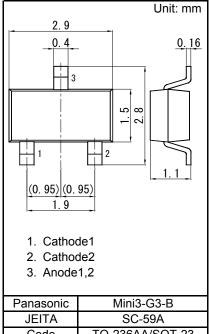
Silicon epitaxial planar type

For high speed switching circuits DA3J102D in Mini3 type package

■ Features

- Short reverse recovery time trr
- · Low terminal capacitance Ct
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: 23
- Basic Part Number : 2 elements anode-common type
- Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

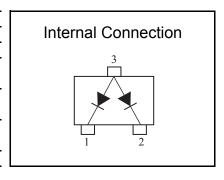


Panasonic	Mini3-G3-B
JEITA	SC-59A
Code	TO-236AA/SOT-23

■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit		
Reverse voltage		VR	80	V	
Maximum peak reverse voltage		VRM	80	V	
Forward current	Single	IF	100	mA	
Forward current	Double	1	150		
Peak forward current	Single	IFM	225	mA	
reak lolwald cullent	Double	II-IVI	340		
Non-repetitive peak	Single	IFSM	500	mA	
forward surge current *1	Double	IFSIVI	750		
Junction temperature		Tj	150	°C	
Operating ambient temperature		Topr	-40 to +85	°C	
Storage temperature		Tstg	-55 to +150	°C	

Note) *1: t = 1 s



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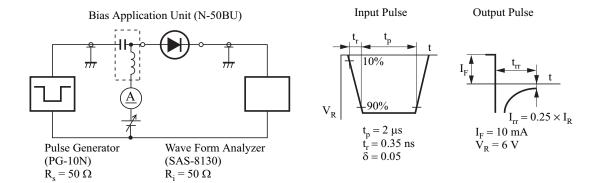
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■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 100 mA			1.2	V
Reverse voltage	VR	IR = 100 μA	80			V
Reverse current	IR	VR = 80 V			100	nA
Terminal capacitance	Ct	VR = 0 V, f = 1 MHz			15	pF
Reverse recovery time *1	trr	IF = 10mA, VR = 6V			10	ns
		Irr = 0.25 x IR				

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
 - 2. Absolute frequency of input and output is 100 MHz.
 - 3. *1: trr test circuit

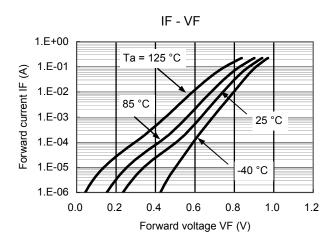


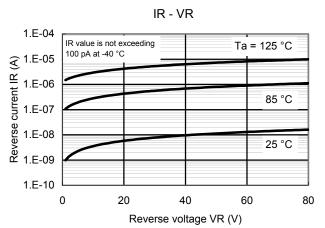
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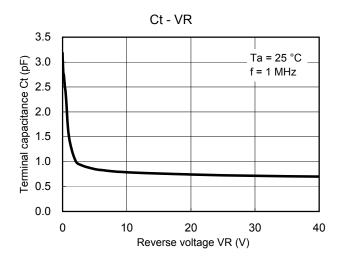
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Technical Data (reference)







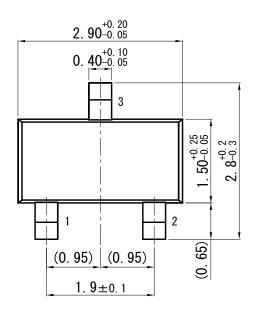
Switching Diode

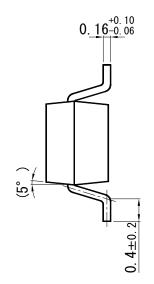
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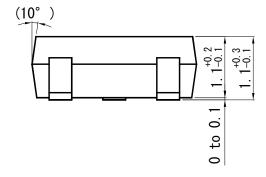
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Mini3-G3-B

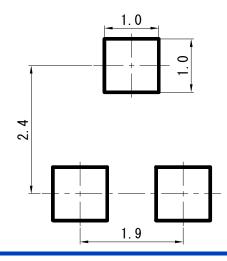
Unit: mm







■ Land Pattern (Reference) (Unit: mm)



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